SCOPE :

This specification applies to the Pb Free high current type SMD inductors for

MSCDRI-8D28-SERIES

PRODUCT INDENTIFICATION

MSCDRI - 8D28 - 100 M

① ② ③ ④

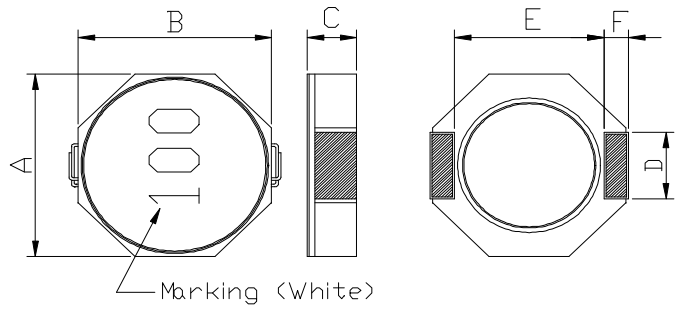
① Product Code

② Dimensions Code

③ Inductance Code

④ Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 8.00±0.3 mm
B: 8.00±0.3 mm
C: 3.00 Max mm
D: 2.50 Typ. mm
E: 6.30 Typ. mm
F: 1.20 Typ. mm

(2) ELECTRICAL SPECIFICATIONS

SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC : CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Ambient temperature ……..... ＋60℃ Max.

(3)-2 Operate temperature range ..... －40℃～＋125℃

(Including self temp. rise)

(3)-3 Storage temperature range ..... －40℃～＋125℃

TABLE 1

MAGLAYERS PT/NO.	Inductance L(μH)	Percent Tolerance	Test Frequency	Resistance RDC(Ω) Max.	Rated DC Current		Marking
					IDC1(A)	IDC2(A)	
MSCDRI-8D28-2R5□	2.5	N	100kHz/0.25V	15.6m	4.50	6.40	2R5
MSCDRI-8D28-3R3□	3.3	M,N	100kHz/0.25V	18.2m	4.00	6.00	3R3
MSCDRI-8D28-3R6□	3.6	M,N	100kHz/0.25V	24.0m	3.80	4.60	3R6
MSCDRI-8D28-4R7□	4.7	M,N	100kHz/0.25V	24.7m	3.40	4.50	4R7
MSCDRI-8D28-7R3□	7.3	N	100kHz/0.25V	39.0m	2.80	3.40	7R3
MSCDRI-8D28-100□	10	M,N	100kHz/0.25V	47.0m	2.50	3.20	100
MSCDRI-8D28-150□	15	M,N	100kHz/0.25V	69.0m	1.90	2.35	150
MSCDRI-8D28-220□	22	M,N	100kHz/0.25V	99.0m	1.60	1.85	220
MSCDRI-8D28-330□	33	M,N	100kHz/0.25V	0.156	1.30	1.45	330
MSCDRI-8D28-470□	47	M,N	100kHz/0.25V	0.195	1.15	1.30	470
MSCDRI-8D28-680□	68	M,N	100kHz/0.25V	0.286	0.92	0.98	680
MSCDRI-8D28-101□	100	M,N	100kHz/0.25V	0.430	0.75	0.80	101

※ □ specify the inductance tolerance,M(±20%),N(±30%)

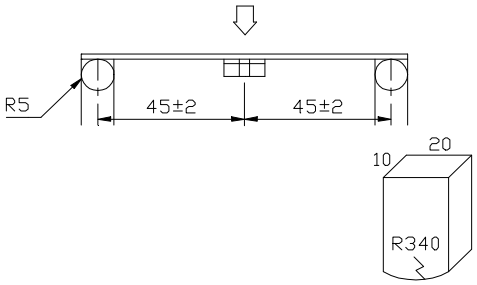
※ IDC1： Based on inductance change (△L/Lo： ≦ drop 35%) @Ambient Temperature : 25℃

IDC2： Based on temperature rise (△T： 40℃ TYP.)

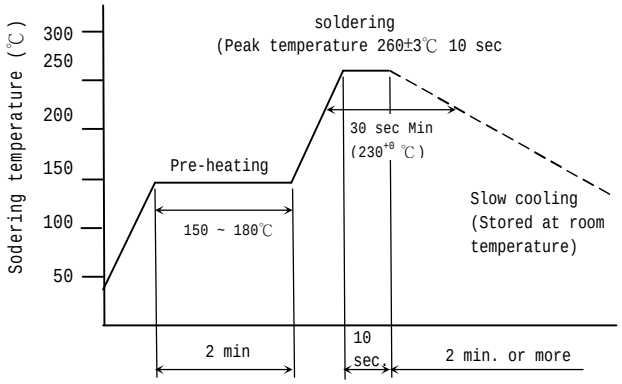
Rated DC Current： The less value which is IDC1 or IDC2.

(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Substrate bending	△L/Lo≦±5% There shall be no mechanical damage or elec-trical damege.	The sample shall be soldered onto the printed circuit board in figure 1 and a load applied unitil the figure in the arrow direction is made approximately 3mm.(keep time 30 seconds) PCB dimension shall the page 7/9 F(Pressurization)  PRESSURE ROD figure-1
Vibration	△L/Lo≦±5% There shall be no mechanical damage.	The sample shall be soldered onto the printed circuit board and when a vibration having an amplitude of 1.52mm and a frequency of from 10 to 55Hz/1 minute repeated should be applied to the 3 directions (X,Y,Z) for 2 hours each. (A total of 6 hours)
Solderability	New solder More than 90%	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated over the whole of the sample before hard, the sample shall then be preheated for about 2 minutes in a temperature of 130～150℃ and after it has been immersed to a depth 0.5mm below for 3±0.2 seconds fully in molten solder M705 with a temperature of 245±5℃. More than 90% of the electrode sections shall be couered with new solder smoothly when the sample is taken out of the solder bath.

MECHANICAL

TEST ITEM	SPECIFICATION	
Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	Temperature profile of reflow soldering  The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation resistance	There shall be no other damage or problems.	DC 100V voltage shall be applied across this sample of top surface and the terminal. The insulation resistance shall be more than 1×10^8 Ω.
Dielectric withstand voltage	There shall be no other damage or problems.	AC 100V voltage shall be applied for 1 minute acrosset the top surface and the terminal of this sample
Temperature characteristics	△L/L20℃ ≦±10% 0～2000 ppm/℃	The test shall be performed after the sample has stabilized in an ambient temperature of -20 to +85℃,and the value calculated based on the value applicable in a normal temperature and narmal humidity shall be △L/L20℃ ≦±10%.

ENVIROMENT CHARACTERISTICS

<table>
<tr><th>TEST ITEM</th><th colspan="2">SPECIFICATION</th></tr>
<tr><td>High temperature storage</td><td>△L/Lo≦±5%

There shall be no mechanical damage.</td><td>The sample shall be left for 96±4 hours in an atmospere with a temperature of 85±2℃ and a normal humidity.
Upon completion of the measurement shall be made after the sample has been left in a normal temperature and normal humidity for 1 hour.</td></tr>
<tr><td>Low temperature storage</td><td>△L/Lo≦±5%

There shall be no mechanical damage.</td><td>The sample shall be left for 96±4 hours in an atmosphere with a temperature of -25±3℃.
Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and normal humidity for 1 hour.</td></tr>
<tr><td>Change of temperature</td><td>△L/Lo≦±5%

There shall be no other dama-ge of problems</td><td>The sample shall be subject to 5 continuos cycles, such as shown in the table 2 below and then it shall be subjected to standard atmospheric conditions for 1 hour, after which measurement shall be made.

table 2
<table>
<tr><th></th><th>Temperature</th><th>Duration</th></tr>
<tr><td>1</td><td>－25±3℃
(Themostat No.1)</td><td>30 min.</td></tr>
<tr><td>2</td><td>Standard atmospheric</td><td>No.1→No.2</td></tr>
<tr><td>3</td><td>85±2℃
(Themostat No.2)</td><td>30 min.</td></tr>
<tr><td>4</td><td>Standard atmospheric</td><td>No.2→No.1</td></tr>
</table></td></tr>
<tr><td>Moisture storage</td><td>△L/Lo≦±5%

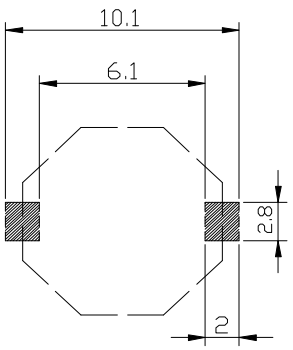
There shall be no mechanical damage.</td><td>The sample shall be left for 96±4 hours in a temperature of 40±2℃ and a humidity(RH) of 90～95%.
Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and normal humidity more than 1 hour.</td></tr>
<tr><td colspan="3">Test conditions：
The sample shall be reflow soldered onto the printed circuit board in every test.</td></tr>
</table>

(5) LAND DIMENSION (Ref.)

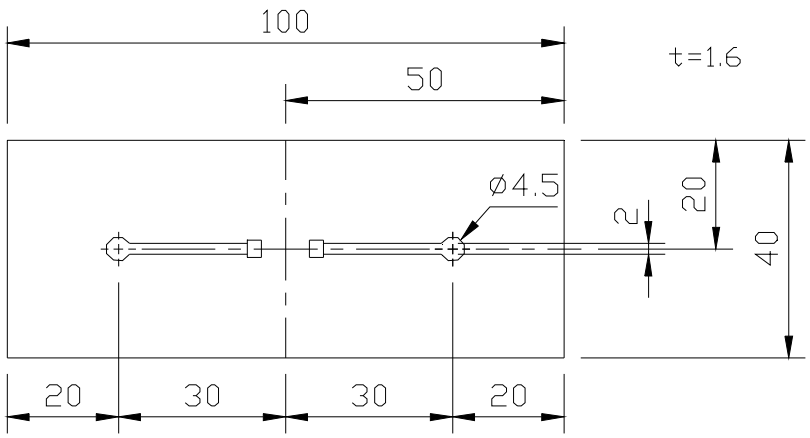
PCB: GLASS EPOXY t＝1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit : mm

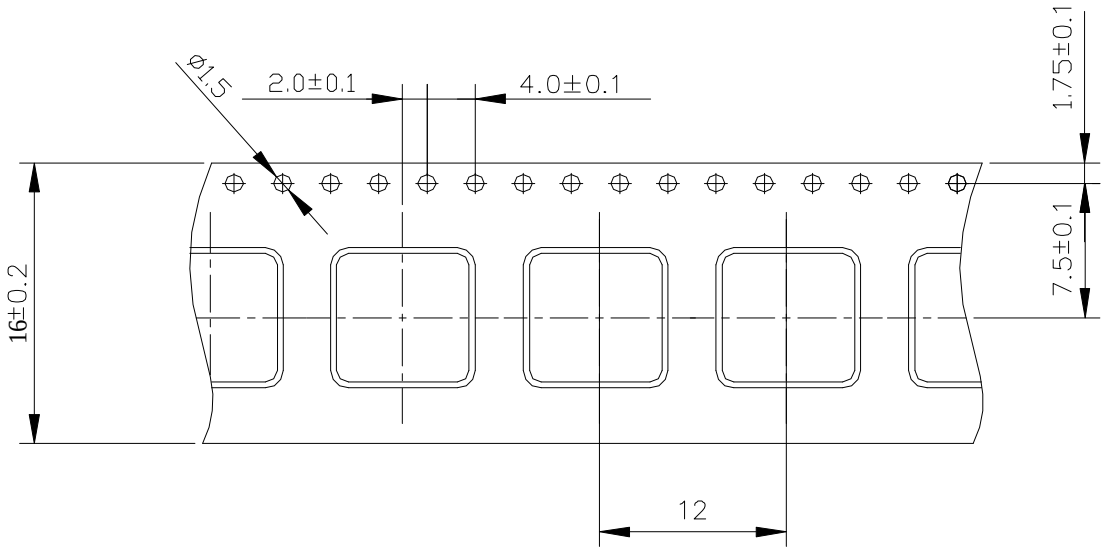


(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD

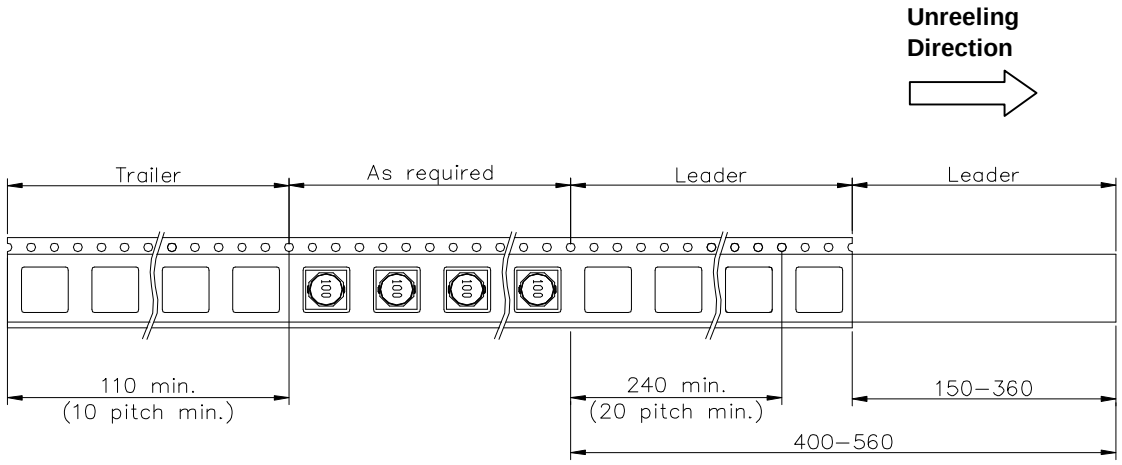


(6) PACKAGING

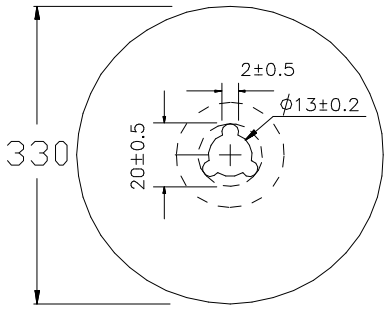
(6)-1 CARRIER TAPE DIMENSIONS (mm)

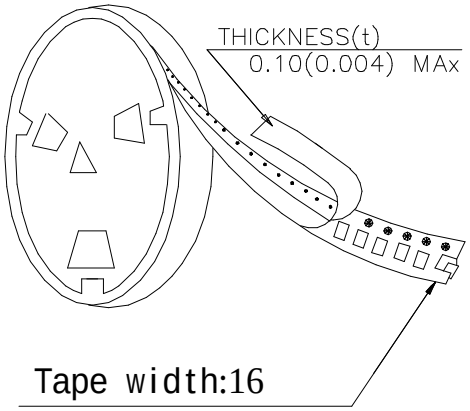


(6)-2 TAPING DIMENSIONS (mm)



(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

1000pcs/Reel

The products are packaged so that no damage will be sustained.